

Low Profile Power 2P Connector

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1. Scope

1.1 Content

This specification covers the requirements for product performance, test methods and quality assurance provisions of Low Profile Power 2P connector.

2. Applicable Documents

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

2.1 Tyco Electronics Specifications:

- A. 109-5000: Test Specification, General Requirements for Testing.
- B. 114-13265: Application Specification, (Economy Power II Contacts and Connectors)

2.2 Industry Document:

A. EIA-364: Electrical Connector/Socket Test Procedures Including Environmental Classifications

2.3 Reference Document:

109-197: Test Specification (AMP Test Specifications vs EIA and IEC Test Methods)

3. Requirements

3.1 Design and Construction:

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2 Materials:

- A. Receptacle Contact:
 - I) Pre-Tin Phosphor Bronze Type(Tin PL 1.0 um min.)
- B. Plug Housing: PET/PC Alloy (UL94V-0), GWT
- C. Header Assembly:
 - I) Header Housing: PA66 (Glass Filled, UL94V-0), GWT
 - II) Post Contact: Tin Plated Brass
- D. TPA: PA66 (Glass Filled, UL94V-0), GWT

3.3 Ratings:

- A. Voltage Rating: 300 VAC, DC
- B. Current Rating: 12A Max

Refer to Fig. 1 for maximum allowable current to be applied.

C. Temperature Rating: -25°C to 105°C

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Wire S	izo	Maximum Allowable Current									
vviie 3	ize	AWG#16	AWG#16 AWG#18 AWG#20 AV								
Pitch	Pos.	404	440	100	0.4						
11.0mm	2	12A	11A	10A	9A						

Fig. 1

D. Temperature Rating: -25°C to 105°C Applicable P.C.B : Thickness 1.6mm

Dia. of thru hole

For tin: 1.65+0.1/-0 mm (Drilled Hole) 1.60+0.1/-0 mm (Punched Hole)

3.4 Performance Requirements and Test Descriptions:

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Fig. 2. All tests shall be performed in the room temperature, unless otherwise specified.

3.5 Test Requirements and Procedures Summary

Para.	Test Items	Requirements	Procedures						
3.5.1	Examination of Product	Meets requirements of product drawing and AMP Specification 114-13265	EIA-364-18. Visual and dimensional (C of C) inspection per product drawing.						
Electrical Requirements									
3.5.2	Termination Resistance (Low Level)	10 mΩ Max. (Initial) 20 mΩ Max. (Final)	EIA-364-23. Subject specimens to 100 milliamperes maximum and 20 millivolts maximum open circuit voltage. See Figure 4.						
3.5.3	Dielectric withstanding Voltage	One minute hold with no breakdown or flashover.	EIA-364-20, Condition I. 1500 volts AC at sea level. Test between adjacent contacts. Leakage current at 5.0 milliamps.						





3.5.4	Insulation Resistance	1000 MΩ Mi 500 MΩ M		EIA-364-21. 500 volts DC, 2 minute hold. Test between adjacent contacts.
3.5.5	Temperature Rising Vs current	30℃ Max. und specified curre current.		EIA-364-70, Method 1. Stabilize at a single current level until 3 readings at 5 minute intervals are within 1°C. See figure 5
		Mechan	ical Requirement	s
3.5.6	Crimp Tensile	Wire Size	Crimp Tensile	EIA-364-8.
	Strength	AWG		Determine crimp tensile at a rate of 25.4 mm per minute.
		#22	44.5 (4.5)	
		#20	62.3(6.3)	
		#18	89 (9.1)	
		#16	100(10.2)	
3.5.7	Post Retention Force	29.4N (3.0 kgf)	Min.	Measure post retention force. Operation Speed: 100mm/min
3.5.8	Contact Retention Force	1. with TPA: 29.4N(5.0kgf)N 2. without TPA 29.4N(3.0kgf)N	:	EIA-364-29B Apply axial load at a rate of 4.4 N per second and hold for 6 seconds.

Fig. 2 (CONT.)

Para.	Test Items	Requirements	Procedures
3.5.9.	Contact Insertion Force	6.9N (700g) Max. per contact	EIA-364-5. Measure force necessary to insert a contact into the housing at a maximum rate of 12.7mm [0.5 in.] per minute.
3.5.10	Connector Mating Force	19.6 N [2.0 Kgf] Max.	EIA-364-13. Measure force necessary to mate specimens with latches disengaged at a maximum rate of 12.7 mm per minute.
3.5.11	Connector Unmating Force	3.92 N [0.4Kgf] Min.	EIA-364-13. Measure force necessary to unmate specimens with latches disengaged at a maximum rate of 12.7 mm per minute.
3.5.12	Durability (Repeated Mate/ Unmating)	20 mΩ Max. (Final)	No. of Cycles : 50 cycles. IEC 60512-9-1

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Fig.2 (CONT.)

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Para.	Test Items	Requirements	Procedures
3.5.13	Vibration (Low Frequency)	No Electrical Discontinuity greater than 1 μ sec. shall occur. 20 mΩ Max. (Final)	EIA-364-28, Test Condition VII, Condition Letter D. Subject mated specimens to 3.10 G's rms between 20 to 500 Hz. Fifteen minutes in each of 3 mutually perpendicular planes.
3.5.14	Physical Shock	No electrical discontinuity greater than 1 μ sec. Shall occur. Final 20 m Ω Max.	EIA-364-27, Condition H. Subject mated specimens to 30 G's half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction applied along 3 mutually perpendicular planes, 18 total shocks.
3.5.15	Solderability	Wet Solder Coverage: 95% Min.	Solder Temperature: 230 ± 5 ℃ Immersion Duration: 3±0.5 seconds Flux: Alpha100 AMP Spec. 109-11
3.5.16	Connector Locking Strength	2 Pos : 49 N (5.0kgf)Min.	EIA-364-98. Measure connector locking strength at a maximum rate of 12.7mm [0.5 in.] per minute.
3.5.17	Contact Mating Force	9.8 N (1 .0kgf)Max.	EIA-364-13. Measure force necessary to mate specimens with latches disengaged at a maximum rate of 12.7 mm per minute.
3.5.18	Contact Unmating Force	Initial 1.96N (0.2Kgf) Min. After 50 Cycle 0.98 N (0.1 Kgf) Min.	EIA-364-13. Measure force necessary to unmate specimens with latches disengaged at a maximum rate of 12.7 mm per minute.
3.5.19	Resistance to Cold	20 mΩ Max. (Final)	Mated connector - 30±3℃, 96 hours AMP Spec. 109-5108-3
3.5.20	Thermal Shock	20 mΩ Max. (Final)	EIA-364-32, Test Condition VII. Subject specimens to 10 cycles between – 55° C and 105°C with 30 minute dwells at temperature extremes.
3.5.21	Humidity- Temperature	Insulation resistance (Final) 500 M Ω Min. Termination resistance 20 m Ω Max. (Final) Dielectric withstanding Voltage: No creeping discharge nor flashover shall occur.	EIA-364-31, Method III. Subject specimens to 10 cycles (10 days) between 25° and 65° C at 80 to 100% RH.

Fig.2 (CONT.)

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Para.	Test Items	Requirements	Procedures
3.5.22	Salt Spray	20 mΩ Max. (Final)	EIA-364-26. Subject mated specimens to 5% salt concentration for 48 hours.
3.5.23	Resistance to Soldering Heat	No physical damage shall occur.	Test connector on PCB. Solder Temperature: 260±5 ℃ Immersion Duration: 5±0.5 sec. AMP Spec. 109-5204 Condition A
3.5.24	H ₂ S	20 mΩ Max. (Final)	Mated connector H₂S Gas: 3±1ppm, 40±2°C, 96hours
3.5.25	Temperature Life (Heat Aging)	20 mΩ Max. (Final)	EIA-364-17, Method A, Test Condition 4, Test Time Condition C. Subject mated specimens to 105° C for 500 hours.
3.5.28	Resistance to Ammonia	20 mΩ Max. (Final)	Subject mated specimens to 3% ammonia solution for 7 hours

Fig.2 (END)



3.6 Product Qualification Test Sequence

Took Evenningtion							-	Test S	Seque	nce(a	1)						
Test Examination	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17
Examination of Product	1,3	1,4	1,3	1	1,3	1,4	1,7	1,7	1,5	1,4	1,4	1,4	1,4	1,5	1,3	1,3	1,3
Termination Resistance (Low Level)							2,4 ,6	2,6	2,4	2,5	2,5	2,5	2,5	2,4			
Dielectric withstanding voltage						3											
Insulation Resistance						2											
Temperature Rising					2												
Vibration(Low Frequency)							5										
Physical Shock							3										
Connector Mating Force								3									
Connector Unmating Force								4									
Connector Locking Strength			2														
Contact Insertion Force				2													
Contact Retention Force						5											
Contact Mating Force		2															
Contact Unmating Force		3															
Crimp Tensile Strength	2																
Durability (Repeated Mate/Unmating)								5									
Post Retention Force																2	
Solderability															2		
Humidity-Temperature																	
Resistance to Soldering Heat																	2
Thermal Shock									3								
Salt Spray										3							
H₂S Gas													3				
Temperature Life (Heat Aging)											3						
Resistance to Cold												3					
Resistance to Ammonia														3			

Fig. 3 (Cont.)

(a) Numbers indicate sequence in which the tests are performed

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3.6 Product Qualification Test Sequence

T 15 1 0		Test Sequence(a)															
Test Examination	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	33	34
Examination of Product	1,4																
Termination Resistance (Low Level)	2,5																
Dielectric withstanding voltage	7																
Insulation Resistance	6																
Temperature Rising																	
Vibration(Low Frequency)																	
Physical Shock																	
Connector Mating Force																	
Connector Unmating Force																	
Connector Locking Strength																	
Contact Insertion Force																	
Contact Retention Force																	
Contact Mating Force																	
Contact Unmating Force																	
Crimp Tensile Strength	3																
Durability (Repeated Mate/Unmating)																	
Post Retention Force																	
Solderability																	
Humidity-Temperature	3																
Resistance to Soldering Heat																	
Thermal Shock																	
Salt Spray																	
H₂S Gas																	
Temperature Life (Heat Aging)																	
Resistance to Cold																	
Resistance to Ammonia																	

Fig. 3 (End)

(a) Numbers indicate sequence in which the tests are performed

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4. Quality Assurance Provisions

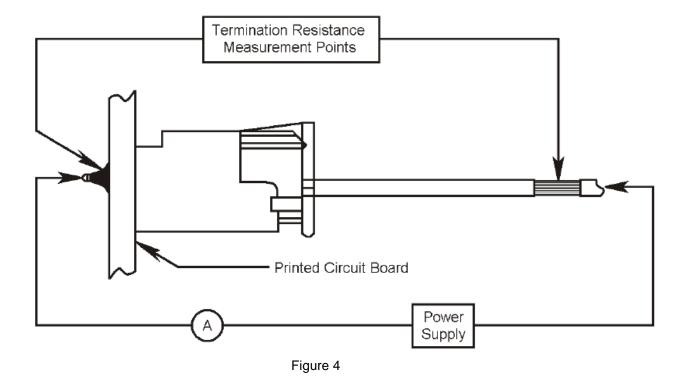
4.1 Test Conditions:

Unless Otherwise specified, all the test shall be performed in any combination of the following test conditions.

4.2 Tests:

4.2.1 Test Specimens:

The test specimens to be employed for the tests shall be conforming to the requirements specified in the applicable product drawings. The crimped contacts shall be prepared in accordance with the requirements of applicable application Specification, 114-13265 Economy Power II Contacts on the wires specified.



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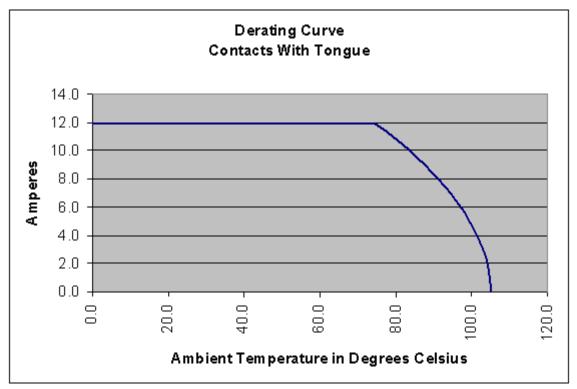


Figure 5



Production Specification

5. REVISION HISTORY

Rev.	REVISION RECORD	DATE
Α	Initial release	21AUG2014

6. SPECIFICATION APPROVAL

Prepared by, BH Cho Checked By,

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